# UN0419N1R7-PD56

ROHS

#### **N-Channel Enhancement Mode MOSFET**

## **Product Summary**

Vps	40V
ID(@Ta=25°C)	190A
$R_{DS(ON)}$ (@VGS=10V $I_D$ =20A)	≤2.4mΩ
$R_{DS(ON)}(@VGS=8V I_D=20A)$	≤3.4mΩ



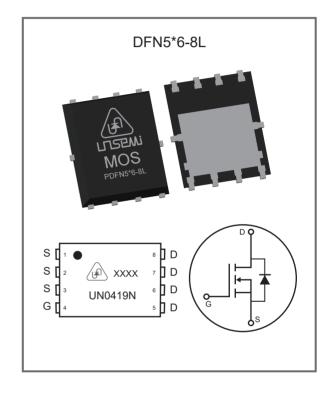
www.unsemi.com.tw

#### **Features**

- ◆ Proprietary Trench Gate Device Design and Processes
- ♦ Low R<sub>DS(ON)</sub>
- ◆ 100% Avalanche Tested
- ◆ Reliable and Rugged
- ◆ RoHS complian

# **Applications**

- ◆ DC/DC Converter
- ◆ Battery Management System
- ◆ Industrial and Motor Drive applications
- Synchronous rectifier applications
- ◆ Half-bridge and full-bridge topologies



## **Package Marking And Ordering information**

Part Number	Package Type	Packaging	Reel(pcs)
UN0419N1R7-PD56	DFN5*6-8L	Tape & Reel	5,000



ROHS

# Absolute Maximum Ratings TC = 25℃ unless otherwise specified

Parameter		Symbol	Maximum	Units	
Drain to Source Voltage		VDs	40	V	
Continuous Drain Current 1)	@TC=25℃	. ID -	190	- A	
Continuous Diam Current	@TC=100°C		120		
Drain Current Pulsed 2)		IDM	570	А	
Gate-Source Voltage		VGS	±20	V	
Single Pulsed Avalanche Energy 3)		EAS	264	mJ	
	@TC=25°C	PD	147	W	
Power Dissipation	@TC=100℃		94	V V	
Junction and Storage Temperature Range		Tstg,TJ	-55~150	${\mathbb C}$	

#### **Thermal Characteristics**

Parameter	Symbol	Max	Units
Thermal Resistance from Junction to Ambient	RθJA	60	°C/W
Thermal Resistance, Junction to Case	ReJC	0.85	°C/W

#### Notes:

- 1) The maximum current rating is silicon wafer limited.
- 2) Single pulse width limited by junction temperature .
- 3) Limited by TJ(MAX), Starting at TJ=25  $^{\circ}$ C, Rg=25 $\Omega$ , L=0.5mH.
- 4) Design parameters, Guaranteed by design, not subject to production.





ROHS

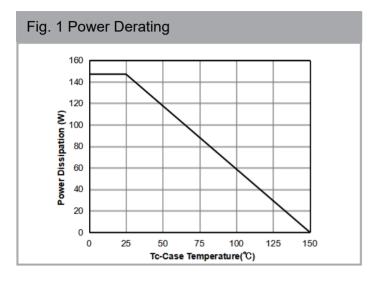
# Electrical Characteristics at Tc = 25°C unless otherwise specified

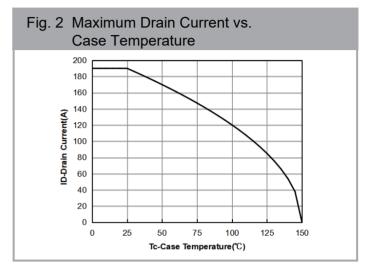
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
STATIC PARAMETERS						
Drain-Source Breakdown Voltage	BVDSS	Vgs = 0V, ID = 250uA	40			V
Drain-Source Leakage Current	IDSS	VDS = 40V , VGS = 0V			1.0	μA
Gate-source leakage current	Igss	Vgs = ±20V , Vps = 0V			±100	nA
Gate-Source Threshold Voltage	VGS(TH)	Vgs = Vps , Ip = 250μA	2.0	3.5	5.0	V
Drain-Source On-State Resistance	Pro(oN)	Vgs = 10V , ID = 20A		1.7	2.4	mΩ
Dialii-Source Oil-State Resistance	Rds(on)	Vgs = 8V , ID = 20A		2.7	3.4	mΩ
Forward Transconductance(GMP)	GFS	VDS = 5.0V, ID = 25A		92		S
E	Body-Diode	PARAMETERS				
Drain-Source Diode Forward Voltage	Vsd	Is = 1A, Vgs = 0V		0.7	1.1	V
Body Diode Reverse Recovery Time	trr	IF = 20A		43		ns
Body Diode Reverse Recovery Charge	Qrr	di/dt = 100A/μs		48		nC
	DYNAMIC	PARAMETERS 4)				
Gate Resistance	Rg	F = 1MHZ		1.5		Ω
Input Capacitance	Ciss	Vgs = 0V		4511		pF
Output Capacitance	Coss	Vps = 20V		859		pF
Reverse Transfer Capacitance	Crss	F = 1MHz		811		pF
Gate charge Total	Qg	Vgs = 10V		110		nC
Gate to Source Charge	Qgs	Vps = 20V		26		nC
Gate to Drain Charge	Qgd	ID = 20A		30		nC
SWITCHING PARAMETERS 4)						
Turn-On Delay Time	td(ON)			15		ns
Turn-On Rise Time	tr	$V_{DS} = 20V, V_{GS} = 10V$ $R_{G} = 1.5Ω$		38		ns
Turn-Off Delay Time	td(OFF)	$RG = 1.5\Omega$		51		ns
Turn-Off Fall Time	tf			42		ns

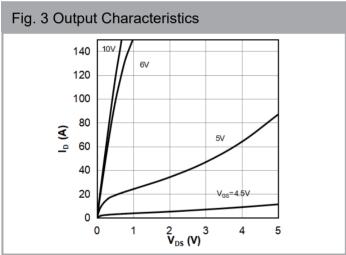


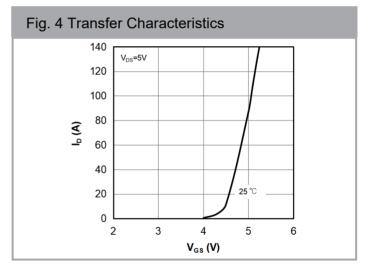
ROHS

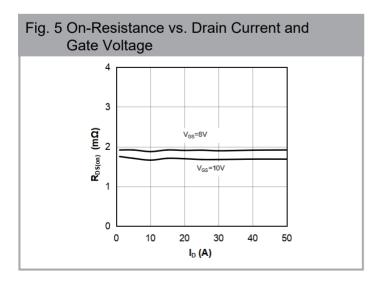
#### **Electrical Characteristics Curves**

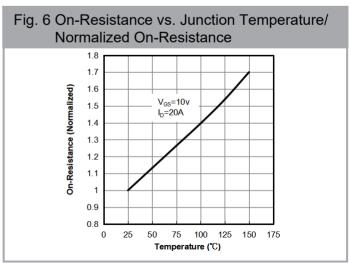








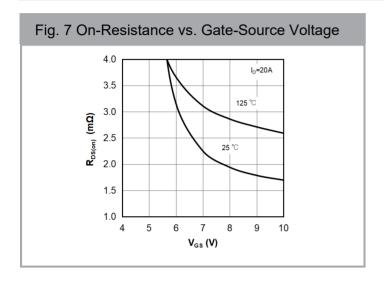


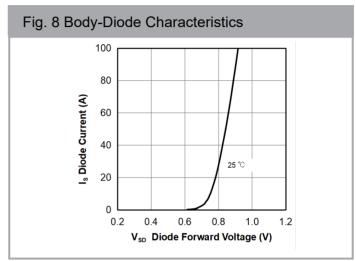


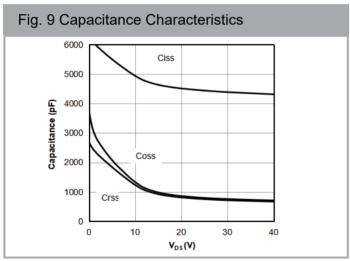


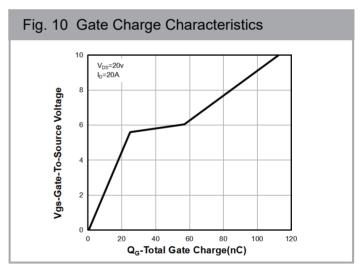
ROHS

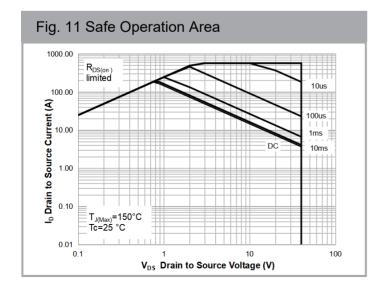
#### **Electrical Characteristics Curves**









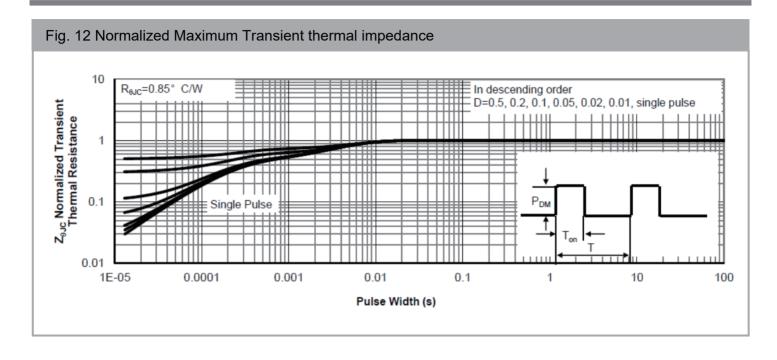






ROHS

#### **Electrical Characteristics Curves**

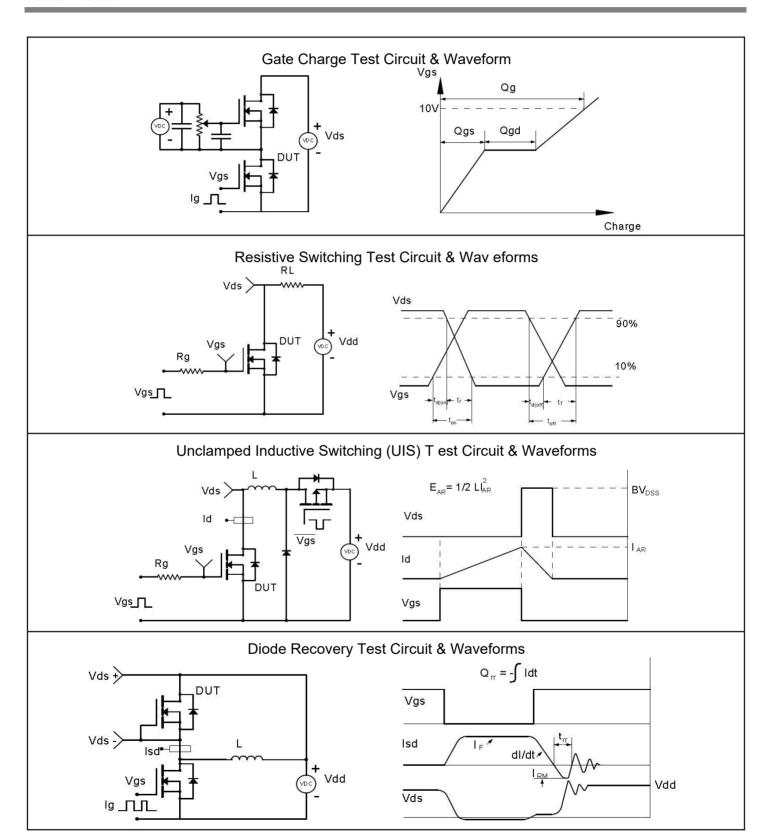






ROHS

#### **Test Circuit**

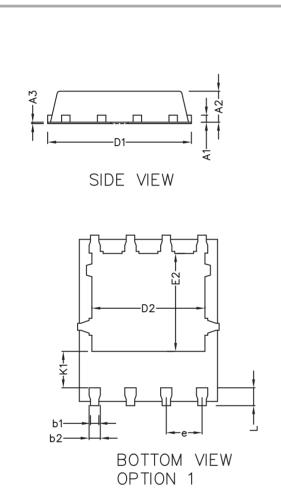




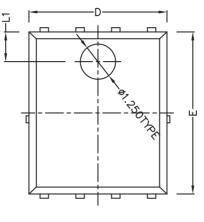


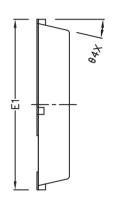
ROHS

# DFN5\*6-8L Package Outine & Dimensions (Units: mm / in)



# PDFN5\*6-8L





TOP VIEW

SIDE VIEW

Symbol	Dimensions In	n Millimeters	Dimensions In Inches		
Syllibol	Min	Max	Min	Max	
A1	(0.254	BSC)	(0.0100 BSC)		
A2	1.000	1.100	0.0394	0.0433	
A3	0.005	-	0.0001	-	
b1	0.250	0.300	0.0098	0.0118	
b2	0.350	0.400	0.0138	0.0157	
D	4.800	4.900	0.1890	0.1929	
D1	5.000	5.100	0.1969	0.2008	
D2	3.910	4.010	0.1539	0.1579	
E	5.650	5.750	0.2224	0.2263	
E1	5.950	6.050	0.2342	0.2381	
E2	3.375	3.475	0.1329	0.1368	
е	(1.270 TYPE)		(0.0500 TYPE)		
L	0.530	0.630	0.0209	0.0248	
L1	1.00 REF		0.0394 REF		
θ	13° TYPE		13° TYPE		
K1	1.235 REF		0.0486 REF		



ROHS

## Disclaimer

UNSEMI RESERVES THE RIGHT TO MAKE CHANGE ON OUR PRODUTS, PRODUCTS SPECIFICATION AND DATA WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

UN SEMICONDUCTOR LIMITED its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "UNSEMI")does not give any representations or warranties for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

In no event shall UNSEMI be liable for any indirect, incidental, punitive, special or consequential damages (including any and all implied warranties, warranties of fitness for particular purpose, non-infringement and merchantability.) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Statements regarding the suitability of products for certain types of applications are based on UNSEMI knowledge of typical requirements that are often placed on UNSEMI products in generic applications. Such statements are not binding, statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify UNSEMI's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Unless otherwise agreed in writing, UNSEMI product is not designed, authorized or warranted to be suitable for use in medical life-saving, or life-sustaining application, nor in applications where failure or malfunction of a UNSEMI product can reasonably be expected to result in personal injury, death or severe property or environmental damage. UNSEMI and its suppliers accept no liability for inclusion or use of UNSEMI products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

All referenced brands, product names, service names and trademarks are the property of their respective owners.